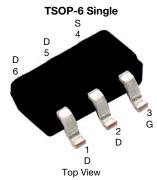
Si3456DDV

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FEATURES

N-Channel 30 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

G O

APPLICATIONS

- Load switch
- HDD
- DC/DC converter



RoHS COMPLIANT HALOGEN FREE Available

(1, 2, 5, 6)

Ó (4) S N-Channel MOSFET

Marking code: AY

PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.040				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.050				
Q _g typ. (nC)	2.8				
I _D (A) ^d	6.3				
Configuration	Single				

ORDERING INFORMATION				
Package	TSOP-6			
Lead (Pb)-free	Si3456DDV-T1-E3			
Lead (Pb)-free and halogen-free	Si3456DDV-T1-GE3			

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	Inless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	M	
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		6.3		
Continuous drain ourrent (T 150 °C)	T _C = 70 °C		5.1		
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	5 ^{a, b}		
	T _A = 70 °C		4 a, b	A	
Pulsed drain current		I _{DM}	20		
	T _C = 25 °C	- I _S	2.2		
Continuous source-drain diode current	T _A = 25 °C		1.4 ^{a, b}		
	T _C = 25 °C		2.7		
Maximum power dissipation	T _C = 70 °C		1.7	14/	
	T _A = 25 °C	P _D	1.7 ^{a, b}	W	
	T _A = 70 °C	1	1.1 ^{a, b}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature)			260	-0	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 5 s	R _{thJA}	61	74	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	38	46	C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 5 s

c. Maximum under steady state conditions is 120 °C/W

d. Based on T_C = 25 °C

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PARAMETER SYMBOL		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$			32	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.2	-	3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zaus asta usltana slusia suuraat		V _{DS} = 30 V, V _{GS} = 0 V		1			
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	-	-	10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	15	-	-	A	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	0.033	0.040	0	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.5 \text{ A}$	-	0.041	0.050	Ω	
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	15	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	325	-		
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	60	-	pF	
Reverse transfer capacitance	C _{rss}		-	30	-		
Total gate charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	-	6	9		
			-	2.8	4.2		
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	1.1	-	nC	
Gate-drain charge	Q _{qd}		-	0.8	-		
Gate resistance	R _g	f = 1 MHz	0.6	2.8	5.6	Ω	
Turn-on delay time	t _{d(on)}		-	12	18		
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 3.8 \Omega$	-	13	20	1	
Turn-off delay time	t _{d(off)}	$I_D \cong 4 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \ \Omega$	-	16	25		
Fall time	t _f		-	11	17		
Turn-on delay time	t _{d(on)}		-	4	8	- ns -	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 3.8 \Omega$	-	9	18		
Turn-off delay time	t _{d(off)}	$I_D \cong 4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	11	20		
Fall time	t _f		-	8	15		
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	1.2		
Pulse diode forward current	I _{SM}		-	-	20	A	
Body diode voltage	V _{SD}	$I_{S} = 4 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	11	20	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 4 A, di/dt = 100 A/μs,	-	4	8	nC	
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	6	_		
Reverse recovery rise time	t _b		_	5	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

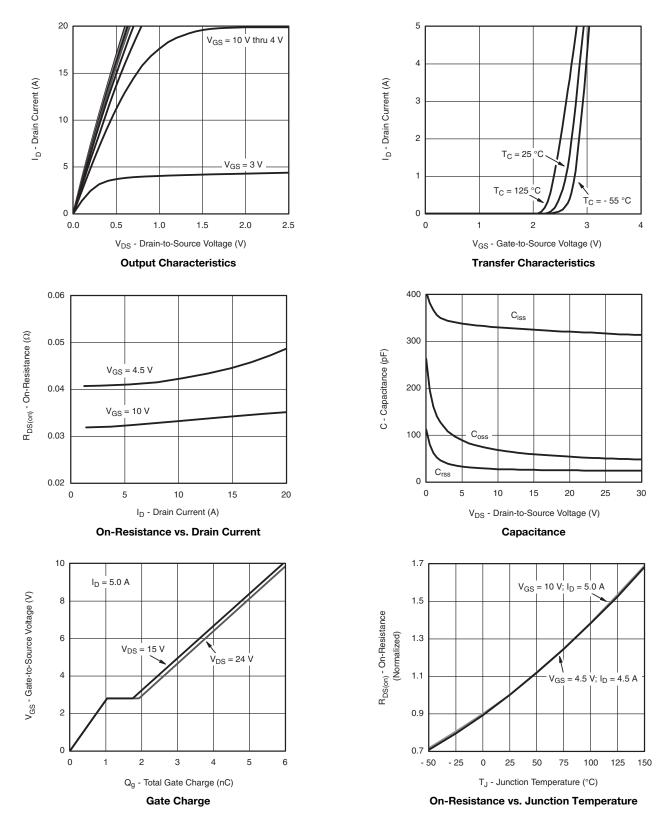
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



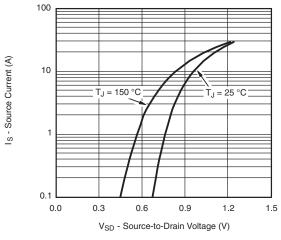
S09-1399-Rev. B, 20-Jul-09

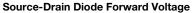


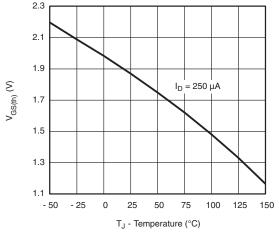
Si3456DDV

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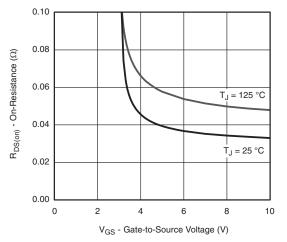
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



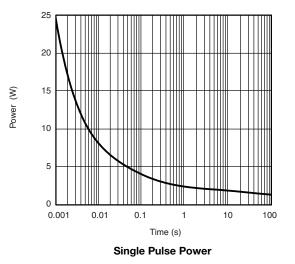


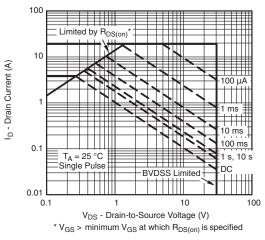


Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage





Safe Operating Area, Junction-to-Ambient

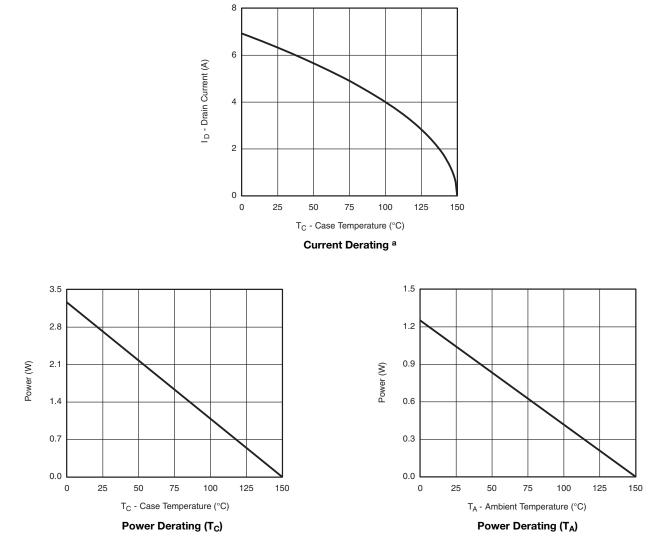
4

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



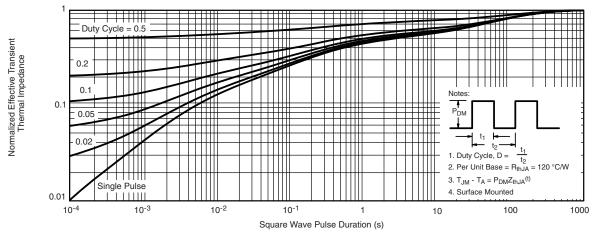
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

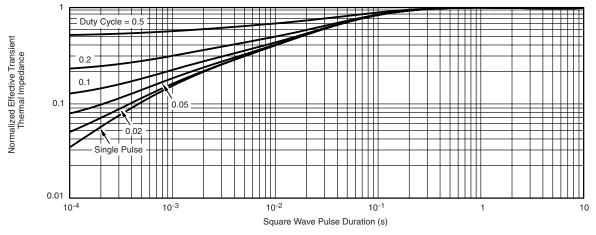


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

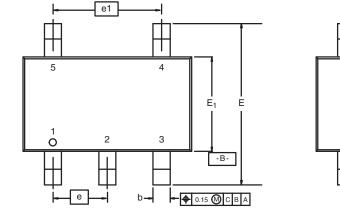
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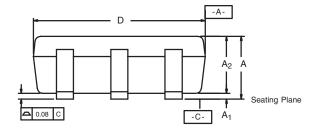
Package Information

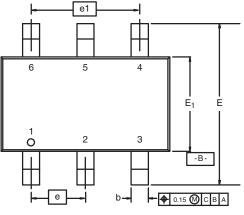
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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

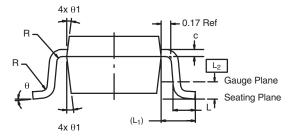


5-LEAD TSOP





6-LEAD TSOP



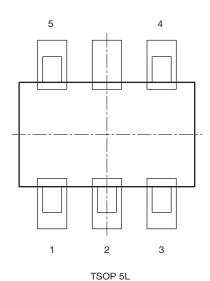
	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
A ₁	0.01	-	0.10	0.0004	-	0.004
A ₂	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
С	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
Е	2.70	2.85	2.98	0.106	0.112	0.117
E ₁	1.55	1.65	1.70	0.061	0.065	0.067
е		0.95 BSC		0.0374 BSC		
e ₁	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L ₁		0.60 Ref		0.024 Ref		
L ₂	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ_1	7° Nom				7° Nom	
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

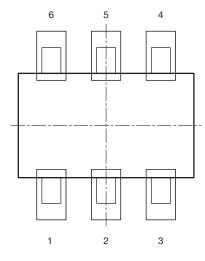
PAD Pattern



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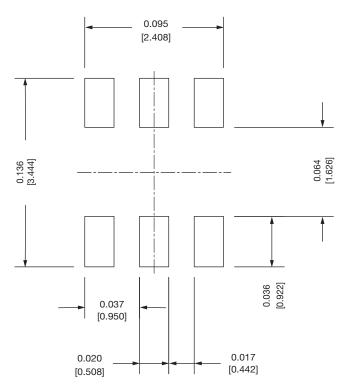
Recommended Land Pattern For TSOP-5L / TSOP-6L











Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev.	B, 24-Oct-2022		
DWG: 3010			



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